SCAS011B - D2957, JULY 1987 - REVISED APRIL 1993

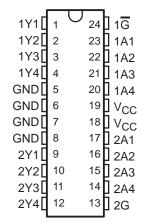
- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Inputs Are TTL-Voltage Compatible
- Flow-Through Architecture Optimizes PCB Layout
- Center-Pin V<sub>CC</sub> and GND Configurations Minimize High-Speed Switching Noise
- EPIC<sup>™</sup> (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline Packages, Plastic Shrink Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

#### description

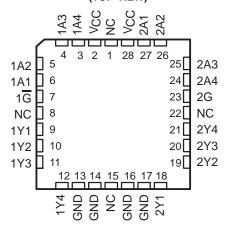
These octal buffers or line drivers are designed specifically to improve both the performance and density of three-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. Taken together with the ACT11240 and ACT11244, these devices provide the choice of selected combinations of inverting and noninverting outputs, symmetrical  $\overline{G}$  (active-low output control) inputs, and complementary G and  $\overline{G}$  inputs. These devices feature high fan-out.

The 54ACT11241 is characterized for operation over the full military temperature range of – 55°C to 125°C. The 74ACT11241 is characterized for operation from – 40°C to 85°C.

#### 54ACT11241 . . . JT PACKAGE 74ACT11241 . . . DB, DW OR NT PACKAGE (TOP VIEW)



# 54ACT11241 . . . FK PACKAGE (TOP VIEW)



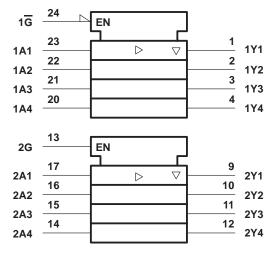
NC - No internal connection

#### **FUNCTION TABLE**

OUTPUT CONTROL 1G	DATA INPUT 1A	OUTPUT 1Y	OUTPUT CONTROL 2G	DATA INPUT 2A	OUTPUT 2Y
Н	Х	Z	L	Х	Z
L	L	L	Н	L	L
L	Н	Н	н н		Н

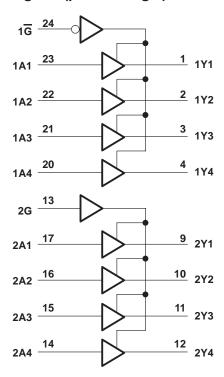
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## logic symbol†



<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

# logic diagram (positive logic)



Pin numbers shown are for the DW, JT, and NT packages.

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V <sub>CC</sub>	
Input voltage range, V <sub>I</sub> (see Note 1)	$\dots$ -0.5 V to V <sub>CC</sub> + 0.5 V
Output voltage range, V <sub>O</sub> (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ )	± 20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> )	$\dots \dots \pm 50 \text{ mA}$
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	$\dots \dots \pm 50 \text{ mA}$
Continuous current through V <sub>CC</sub> or GND	$\dots \dots \pm 200 \text{ mA}$
Storage temperature range	65°C to 150°C

<sup>‡</sup>Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at the se or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## recommended operating conditions

		54ACT11241		74ACT	LINUT	
		MIN	MAX	MIN	MAX	UNIT
VCC	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2		2		V
$V_{IL}$	Low-level input voltage		0.8		0.8	V
٧ <sub>I</sub>	Input voltage	0	VCC	0	VCC	V
VO	Output voltage	0	VCC	0	VCC	V
ЮН	High-level output current		-24		-24	mA
loL	Low-level output current		24		24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	0	10	ns/V
TA	Operating free-air temperature	-55	125	- 40	85	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEGT CONDITIONS	.,	T <sub>A</sub> = 25°C			54ACT11241		74ACT11241		
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
		4.5 V	4.4			4.4		4.4		
	ΙΟΗ = - 50 μΑ	5.5 V	5.4			5.4		5.4		
.,	1	4.5 V	3.94			3.7		3.8		
VOH	I <sub>OH</sub> = – 24 mA	5.5 V	4.94			4.7		4.8		V
	$I_{OH} = -50 \text{ mA}^{\dagger}$	5.5 V				3.85				
	I <sub>OH</sub> = - 75 mA <sup>†</sup>	5.5 V						3.85		
	I <sub>OL</sub> = 50 μA	4.5 V			0.1		0.1		0.1	V
		5.5 V			0.1		0.1		0.1	
.,	I <sub>OL</sub> = 24 mA	4.5 V			0.36		0.5		0.44	
$V_{OL}$		5.5 V			0.36		0.5		0.44	
	$I_{OL} = 50 \text{ mA}^{\dagger}$	5.5 V					1.65			
	I <sub>OL</sub> = 75 mA <sup>†</sup>	5.5 V							1.65	
loz	V <sub>O</sub> = V <sub>CC</sub> or GND	5.5 V			± 0.5		± 10		±5	μΑ
IJ	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5 V			± 0.1		± 1		±1	μΑ
ICC	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		160		80	μΑ
Δl <sub>CC</sub> ‡	One input at 3.4 V, Other inputs at GND or V <sub>CC</sub>	5.5 V	_	_	0.9	_	1		1	mA
Ci	V <sub>I</sub> = V <sub>CC</sub> or GND	5 V		4						pF
Co	V <sub>O</sub> = V <sub>CC</sub> or GND	5 V		10						pF

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

<sup>‡</sup> This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or VCC.

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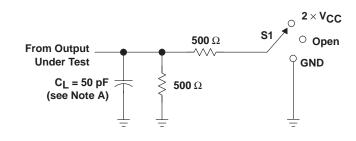
# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

FROM TO		T <sub>A</sub> = 25°C		54ACT11241		74ACT11241				
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
t <sub>PLH</sub>	^	V	1.5	6.6	9	1.5	10.7	1.5	10	
t <sub>PHL</sub>	А	Y	1.5	6.3	8.5	1.5	9.5	1.5	9.1	
<sup>t</sup> PZH	G or <del>G</del>	V	1.5	7.5	11.3	1.5	13	1.5	12.3	
t <sub>PZL</sub>	G or G	Y	1.5	7.4	10.5	1.5	11.9	1.5	11.3	ns
t <sub>PHZ</sub>	G or $\overline{G}$		1.5	7.6	10.6	1.5	11.4	1.5	11	
t <sub>PLZ</sub>	G or G	Y	1.5	8.2	11.2	1.5	12	1.5	11.7	

### operating characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C

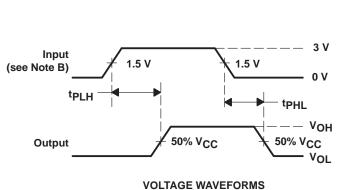
PARAMETER			TEST CONDITIONS	TYP	UNIT
C. Baurar dissination conscitutes and buffer		Outputs enabled	0 50 5 ( ( )	27	_
C <sub>pd</sub>	Power dissipation capacitance per buffer	Outputs disabled	C <sub>L</sub> = 50 pF, f = 1 MHz	9	pF

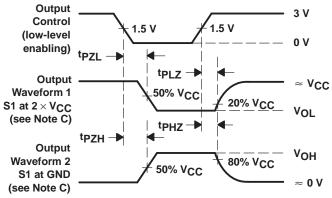
#### PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	2×V <sub>CC</sub>
tPHZ/tPZH	GND





**VOLTAGE WAVEFORMS** 

NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f = 3 \text{ ns}$ ,  $t_f = 3 \text{ ns}$ .
- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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